

Electronic Patent Application Fee Transmittal

Application Number:	10560405			
Filing Date:	12-Dec-2005			
Title of Invention:	Method of bonding microstructured substrates			
First Named Inventor/Applicant Name:	Isabelle Chartier			
Filer:	Suvashis Bhattacharya/Monica Pizarro			
Attorney Docket Number:	434299-678			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	540	540
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1110	1110
Miscellaneous:				
Total in USD (\$)				1650